

2RD-8 Series

Description

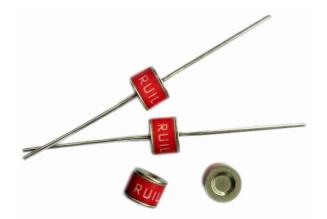
GDT is placed in front of, and in parallel with, sensitive telecom equipment such as power lines, communication lines, signal lines and data transmission lines to help protect them from damage caused by transient surge voltages that may result from lightning strikes and equipment switching operations. These devices do not influence the signal in normal operation. However, in the event of an overvoltage surge, such as a lightning strike, the GDT switches to a low impedance state and diverts the energy away from the sensitive equipment.

Our GDT offer a high level of surge protection, a broad voltage range, low capacitance, and many form factors including new surface mount devices, which makes them suitable for applications such as Main Distribution Frame (MDF) modules, high data-rate telecom applications (e.g. ADSL, VDSL), and surge protection on power lines. Their low capacitance also results in less signal distortion. When used in a coordinated circuit protection solution with PolySwitch devices, they can help equipment manufacturers meet stringent safety regulatory standards.

Features

- I Excellent response to fast rising transients
- I Stable breakdown voltage
- I GHz working frequency
- I 8/20µs Impulse current capability: 20KA
- I Non-Radioactive
- I Ultra Low capacitance (<1.5pF)
- I Lead-free compliant
- I RoHS and REACH compliant
- I UL 497B Recognized: E465335
- I Size: Φ8mm*6mm
- I Storage and operational temperature: -40~+90°C

Part Number Code

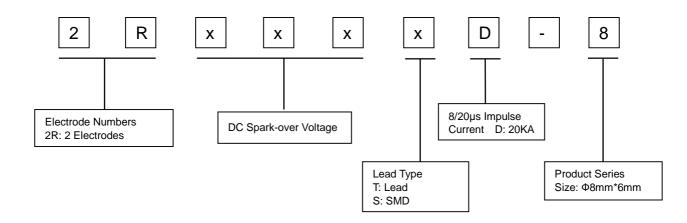


Electrical symbol



Applications

- I MDF modules
- I xDSL equipment
- I RF systems
- I Antenna
- Base stations
- Repeaters, Modems
- I Telephone Interface, Line cards
- I Data communication equipment
- I Line test equipment
- I Power supplies
 - Surge protectors, Alarm systems



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Electrical Characteristics

Part Number		DC Spark-over Voltage ^{1) 2)} @100V/S	Impulse Spark-over Voltage		Insulation	Capacitance @1MHz	Life Ratings			
					Resistance		Impulse Discharge		-	Impulse Life
			100V/µS	1KV/µS	3)		Current @8/20µS		Current @50Hz 1S	@10/1000µS 100A
			Max	Max	Min	Max	Nominal ±5 times	Max 1 time	Nominal 5 times	Min
DIP	SMD	v	v	v	GΩ	pF	KA	KA	Α	Times
2R075TD-8	2R075SD-8	75±20%	500	600	1	1.5	20	25	20	300
2R090TD-8	2R090SD-8	90±20%	500	600	1	1.5	20	25	20	300
2R150TD-8	2R150SD-8	150±20%	500	600	1	1.5	20	25	20	300
2R230TD-8	2R230SD-8	230±20%	600	700	1	1.5	20	25	20	300
2R250TD-8	2R250SD-8	250±20%	600	700	1	1.5	20	25	20	300
2R300TD-8	2R300SD-8	300±20%	750	850	1	1.5	20	25	20	300
2R350TD-8	2R350SD-8	350±20%	800	900	1	1.5	20	25	20	300
2R420TD-8	2R420SD-8	420±20%	900	1000	1	1.5	20	25	20	300
2R470TD-8	2R470SD-8	470±20%	900	1100	1	1.5	20	25	20	300
2R600TD-8	2R600SD-8	600±20%	1000	1200	1	1.5	20	25	20	300
2R800TD-8	2R800SD-8	800±20%	1400	1600	1	1.5	20	25	20	300
Glow Voltage at	: 10mA				~60V					
Arc Voltage at 1	A				~10V					
Glow to Arc tran	sition Current				~1.0A					
Weight			1.7g ·1.25g							
Operation and s	storage temperatu	ıre			40~+90	°C				
Climatic catego	ry (IEC 60068-1).				40/90/21					
Marking, red ne	gative				XXX	N XXX Y Nominal voltag				
Surface treatme	ent					Nickel Plated Matte-tin plated	1			

¹⁾ At delivery AQL 0.65 level II, DIN ISO 2859

²⁾ In ionized mode

³⁾ Insulation Resistance Measuring Voltage:

75V at DC 25V

90V~150V at DC 50V

Other at DC 100V

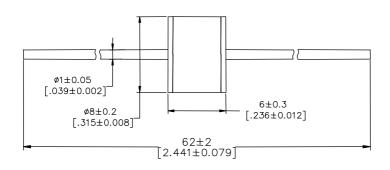
Terms in accordance with ITU-T Rec. K.12, IEC 61643-311, GB/T 9043.

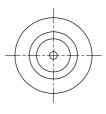
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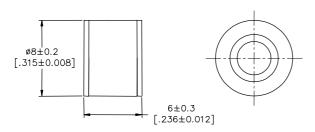
Dimensions (Unit: mm/inch)

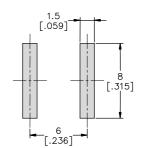
DIP Series (2RxxxTD-8)





SMD Series (2RxxxSD-8)



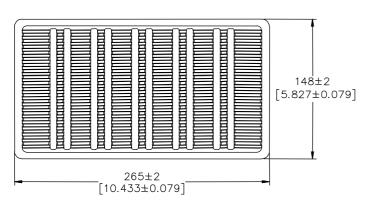


Recommended Soldering Pad Layout

Packaging Information (Unit: mm/inch)

Axial Packaging (Bulk)

Plastic Tray



Packaging Quantity:

1,00 PCS per Plastic Tray

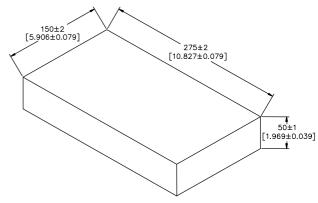
5 Plastic Trays per inner box

500 PCS per inner box

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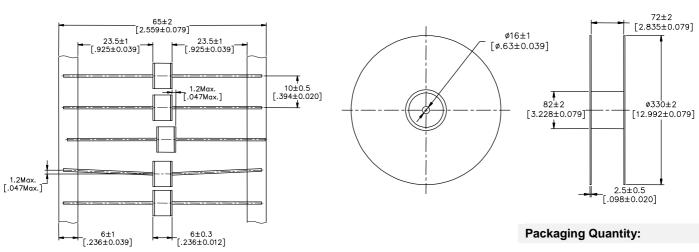
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Axial Packaging (Tape & Reel)

Таре

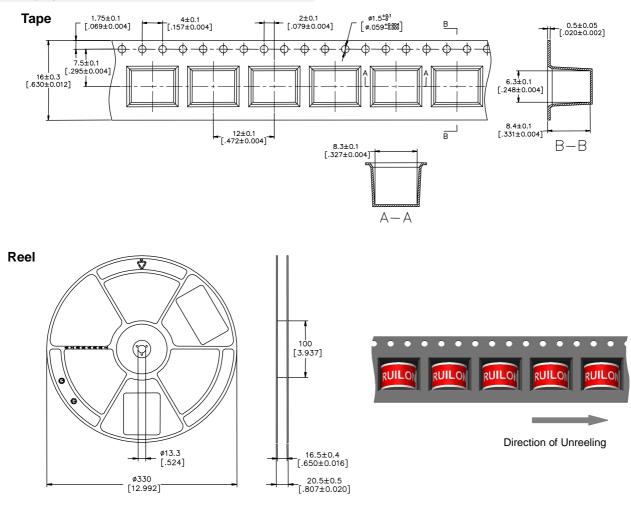
ELECTRONICS

Reel



800 PCS per reel

SMD Packaging (Tape & Reel)



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Inner box ³³⁵ ^{13.189]} ⁷⁰ ⁷⁰ ⁷⁰ ^{2.756]}

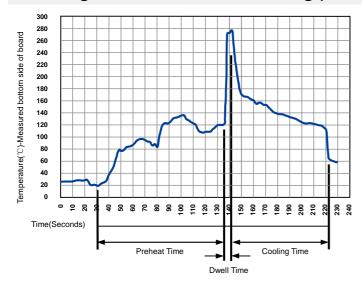
Packaging Quantity: 500 PCS per reel (13")

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3 reels per inner box

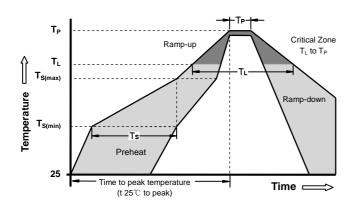
1,500 PCS per inner box

Soldering Parameters - Wave soldering (Thru-Hole Devices)



Wave Soldering Condition		Pb-Free assembly		
Preheat	Temperature Min	100°C		
	Temperature Max	150°C		
	Time (Min to Max)	60-180 Seconds		
Solder Pot Temperature		280°C Max		
Solder Dw	ell Time	2-5 Seconds		

Soldering Parameters - Reflow Soldering (Surface Mount Devices)



Reflow Co	ndition	Pb - Free assembly		
	-Temperature Min (T _{s(min)})	150°C		
Preheat	-Temperature Max (T _{s(max)})	200°C		
	- Time (min to max) (t _s)	60 -180 Seconds		
Average ramp up rate (Liquids Temp T _L) to peak		3°C/second max		
T _{S(max)} to T	L - Ramp-up Rate	5°C/second max		
Reflow	- Temperature (T _⊾) (Liquids)	217°C		
	- Time (min to max) (t _s)	60 -150 Seconds		
Peak Tem	perature (T _P)	260 +0/-5°C		
Time withi Temperatu	in 5°C of actual peak ure (t _p)	10 - 30 Seconds		
Ramp-dow	vn Rate	6°C/second max		
Time 25°C	to peak Temperature (T _P)	8 minutes Max		
Do not exc	ceed	260°C		

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Specifications are subject to change without notice. Please refer to http://www.ruilon.com.cn for current information.